	L #	Hits	Search Text	DBs	Time Stamp
1	L1	79	canella.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/07/23 13:47
2	L8	145	361/769,787.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/07/23 14:51
3	L15	3	3569790.URPN.	IBM_TDB USPAT	2002/07/23 14:30
4	L35	63698	(ball bump bead) near20 spring	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/07/23 15:14
5	L42	246683	test$3 near20 (device IC circuit chip die)	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/07/23 15:04
6	L49	1541	35 and 42	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/07/23 15:04
7	L56	258	35 same 42	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/07/23 15:05
8	L63	270309	(opening hole via socket) near20 spring	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/07/23 15:15
9	L70	23040	35 and 63	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/07/23 15:15
10	L77	595	35 and 63 and 42	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/07/23 15:16
11	L84	1	"4858074".PN.	IBM_TDB USPAT	2002/07/23 16:36
12	L85	1	"5791914".PN.	USPAT	2002/07/23 16:37
13	L86	1	"6043666".PN.	USPAT	2002/07/23 16:37
14	L87	1	"5865632".PN.	USPAT	2002/07/23 16:37
15	L88	4	5865632.URPN.	USPAT	2002/07/23 16:38
16	L89	1	"5461326".PN.	USPAT	2002/07/23 16:39
17	L90	1	"5225773".PN.	USPAT	2002/07/23 16:39
18	L91	1	"5200695".PN.	USPAT	2002/07/23 16:40
19	L92	1	6043666.URPN.	USPAT	2002/07/23 16:40
20	L93	1	"5791914".PN.	USPAT	2002/07/23 17:16
21	L94	1	"5174763".PN.	USPAT	2002/07/23 17:16
22	L95	1	"4199209".PN.	USPAT	2002/07/23 17:16
23	L96	1	"4199209".PN.	USPAT	2002/07/23 17:16
24	L97	1	"4029375".PN.	USPAT	2002/07/23 17:16
25	L98	0	6033233.URPN.	USPAT	2002/07/23 17:17
26	L99	2	4147397.URPN.	USPAT	2002/07/23 17:44